Remarks

The Office Action mailed December 9, 2005 has been carefully reviewed and the following remarks have been made in consequence thereof.

Claims 18-33 are now pending in this application. Claims 1-17 are canceled without prejudice, waiver, or disclaimer. Claims 18-32 are rejected. Claims 18, 20, 26, 28, and 29 have been amended. Claim 33 has been newly added. No new matter has been added. No fees are due for the newly added claim.

Applicants acknowledge that the restriction requirement has been made final, and Applicants have cancelled Claims 1-17, which were withdrawn from prosecution as a result of the restriction requirement.

The rejection of Claims 18-32 under 35 U.S.C. § 102(e) as being anticipated by Renkes et al. (U.S. Patent No. 6,331,742) is respectfully traversed.

Renkes et al. describe a cover that is placed over a base member (12) to form an enclosure (column 4, lines 40-41). The cover includes openings so that a plurality of spade terminals of a run capacitor and power leads from a power source can be connected to a plurality of appropriate receptacles and terminals (column 4, lines 45-48). The cover also includes a plurality of openings which align with a plurality of terminals (36A and 36B) (column 4, lines 48-50). A plurality of leads extending from a remotely mounted start capacitor are inserted through such cover openings and into electrical engagement with the terminals (36A and 36B) (column 4, lines 50-52). The cover further includes a run capacitor support arm which facilitates securing a run capacitor to a module including the base member (column 4, lines 52-54).

Claim 18 recites a run capacitor/positive temperature coefficient resistor/overload (CAP/PTCR/OL) assembly cover configured to couple to a PTCR/OL base comprising "a first surface; a plurality of sidewalls that extend from said first surface and are integrally formed with said first surface, said sidewalls extend from said first surface and form a compartment that is sized to at least partially receive a run capacitor therein; at least one aperture extending through said cover

internal to said compartment; a second surface, opposite to said first surface; and a plurality of projections extending from said second surface."

Renkes et al. do not describe or suggest a run capacitor/positive temperature coefficient resistor/overload (CAP/PTCR/OL) assembly cover as recited in Claim 18. Specifically, Renkes et al. do not describe or suggest a cover including a plurality of sidewalls that extend from the first surface and are integrally formed with the first surface, the sidewalls extend from the first surface and form a compartment that is sized to at least partially receive a run capacitor therein. Rather, Renkes et al. describe a cover that includes a plurality of cover openings which align with a plurality of terminals. A plurality of leads extending from a remotely mounted start capacitor are inserted through the cover openings and into electrical engagement with the terminals. The cover further includes a run capacitor support arm which facilitates securing a run capacitor to a module including the base member. The cover includes openings so that a plurality of spade terminals of the run capacitor can be connected to a plurality of appropriate receptacles and terminals. A description, in Renkes et al., of the module secured to the run capacitor and of the cover including the openings for receiving the terminals of the run capacitor does not teach a compartment sized to at least partially receive a run capacitor as recited in Claim 1. Accordingly, Renkes et al. do not describe or suggest a cover including the sidewalls that form a compartment sized to at least partially receive a run capacitor. Thus, for the reasons set forth above, Claim 18 is submitted to be patentable over Renkes et al.

Claims 19-25 depend, directly or indirectly, from independent Claim 18. When the recitations of Claims 19-25 are considered in combination with the recitations of Claim 18, Applicants submit that Claims 19-25 likewise are patentable over Renkes et al.

Claim 26 recites a run capacitor/positive temperature coefficient resistor/overload (CAP/PTCR/OL) assembly cover configured to couple to a PTCR/OL base comprising "a first surface; a plurality of sidewalls that extend from said first surface and are integrally formed with said first surface, said sidewalls extend from said first surface and form a platform that is sized to at least partially receive a run capacitor thereon, wherein said cover is configured to couple to an

enclosure configured to enclose at least a portion of the run capacitor; at least one aperture extending through said platform; a second surface, opposite to said first surface; and a plurality of projections extending from said second surface."

Renkes et al. do not describe or suggest a run capacitor/positive temperature coefficient resistor/overload (CAP/PTCR/OL) assembly cover as recited in Claim 26. Specifically, Renkes et al. do not describe or suggest a plurality of sidewalls that extend from the first surface and are integrally formed with the first surface, the sidewalls extend from the first surface and form a platform that is sized to at least partially receive a run capacitor thereon, where the cover is configured to couple to an enclosure configured to enclose at least a portion of the run capacitor. Rather, Renkes et al. describe a cover that includes a plurality of cover openings which align with a plurality of terminals. A plurality of leads extending from a remotely mounted start capacitor are inserted through the cover openings and into electrical engagement with the terminals. The cover further includes a run capacitor support arm which facilitates securing a run capacitor to a module including the base member. The cover includes openings so that a plurality of spade terminals of the run capacitor can be connected to a plurality of appropriate receptacles and terminals. A description, in Renkes et al., of the module secured to the run capacitor and of the cover including the openings for receiving the terminals of the run capacitor does not teach an enclosure configured to enclose at least a portion of the run capacitor as recited in Claim 1. Accordingly, Koehler et al. do not describe or suggest the cover configured to coupled to an enclosure configured to enclose at least a portion of the run capacitor. Thus, for the reasons set forth above, Claim 26 is submitted to be patentable over Renkes et al.

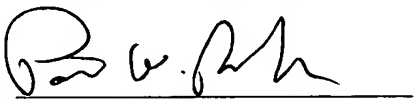
Claims 27-32 depend, directly or indirectly, from independent Claim 26. When the recitations of Claims 27-32 are considered in combination with the recitations of Claim 26, Applicants submit that Claims 27-32 likewise are patentable over Renkes et al.

For at least the reasons set forth above, Applicants respectfully request that the Section 102 rejection of Claims 18-32 be withdrawn.

Newly added Claim 33 depends from independent Claim 1, which is submitted to be in condition for allowance and is patentable over the cited art. For at least the reasons set forth above, Applicants respectfully submit that Claim 33 is also patentable over the cited art.

In view of the foregoing amendment and remarks, all the claims now active in this application are believed to be in condition for allowance. Reconsideration and favorable action is respectfully solicited.

Respectfully Submitted,



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